

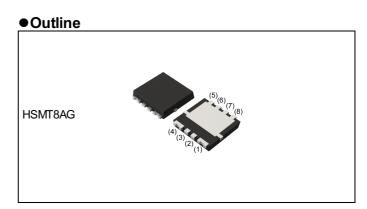
Pch -40V -27A Power MOSFET

Datasheet

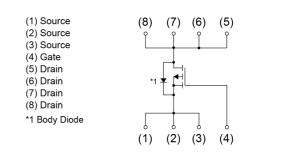
V _{DSS}	-40V		
R _{DS(on)} (Max.)	22.0mΩ		
I _D	±27A		
P _D	69W		

Features

- 1) Small high-powered package
- 2) Realization of high mounting reliability by original terminal and plating treatment
- 3) AEC-Q101 Qualified



Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	12
	Quantity (pcs)	3000
	Taping code	ТСВ
	Marking	G270BJ

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter		Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	-40	V	
Continuous drain current V _{GS} = -10V		۱ _D *1	±27	Α	
Pulsed drain current	I _{DP} *2	±54	А		
Gate - Source voltage		V _{GSS}	+5/-20	V	
Avalanche current, single pulse		I _{AS} *3	18	А	
Avalanche energy, single pulse		E_{AS}^{*3}	24	mJ	
Power dissipation		P _D ^{*1}	69	W	
Junction temperature		Tj	150	°C	
Operating junction and storage ten	T _{stg}	-55 to +150	°C		

Application

ADAS/Info./Lighting/Body

•Thermal resistance

Parameter	Symbol	Values			Unit
Falameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*1}	-	-	1.8	°C/W

•Electrical characteristics (T_a = 25°C)

Deremeter	Currence of	Conditions		Values		1.1:4
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = -1mA$		-40	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = -1mA$ referenced to 25°C		-	-28	-	mV/°C
Zero gate voltage drain current	I_{DSS} V_{DS} = -32V, V_{GS} = 0V		-	-	-1	μA
Gate - Source leakage current	I_{GSS} V_{GS} = +5/-20V, V_{DS} = 0V		-	-	±500	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -485µA	-1.0	-	-2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = -485μA referenced to 25°C	-	3.1	-	mV/°C
Static drain - source	D *4	V _{GS} = -10V, I _D = -27A	-	17.6	22.0	
on - state resistance	$R_{DS(on)}^{*4}$	V _{GS} = -4.5V, I _D = -13A	-	22.0	27.0	mΩ
Gate resistance	R_G f = 1MHz, open drain		-	16	-	Ω
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = -5V, I _D = -10A	11	-	-	S

*1 T_c=25°C , Limited only by maximum junction temperature T_j=150°C.

*2 Pw $\leq 10\mu s$, Duty cycle $\leq 1\%$

*3 L=0.1mH, V_{DD}=-20V, R_G=25 Ω , Starting T_i=25°C, See Fig.3-1,3-2

*4 Pulsed



•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphol	Conditions		Unit			
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	1810	-		
Output capacitance	C _{oss}	V _{DS} = -20V	-	230	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	155	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq -20V, V_{GS} = -10V$	-	10	-		
Rise time	t _r *4	I _D = -10A	-	15	-		
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 2\Omega$	-	126	-	ns	
Fall time	t _f *4	R _G = 1Ω	-	37	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Currence of	Conditions		Values			1 1	
Parameter	Symbol			Min.	Тур.	Max.	Unit	
Total gata abarga	0		V _{GS} = -10V	-	32.0	-		
Total gate charge	Q _g	'	V _{DD} ≃ -20V		-	16.3	-	nC
Gate - Source charge	Q _{gs}	I _D = -10A	V _{GS} = -4.5V	-	3.5	-	nc	
Gate - Drain charge	Q_{gd}			-	3.7	-		

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Sumbol	Conditiono		Linit		
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Continuous forward current	I _S	T _a = 25℃	-	-	-27	А
Pulse forward current	I_{SP}^{*2}	$T_{a} = 25 C$	-	-	-54	А
Forward voltage	V _{SD}	V _{GS} = 0V, I _S = -27A	-	-	-1.2	V
Reverse recovery time	t _{rr}	I _S = -10A, V _{GS} =0V	-	25	-	ns
Reverse recovery charge	Q _{rr}	di/dt = 100A/µs	-	18	-	nC



• Electrical characteristic curves

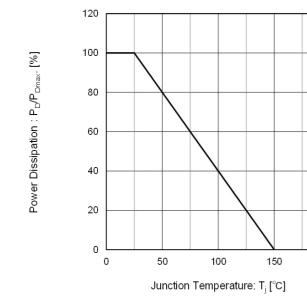


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

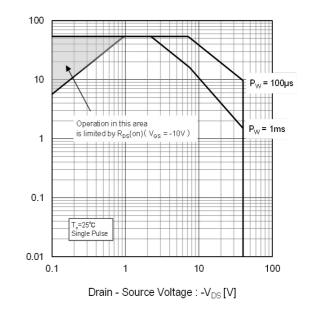


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

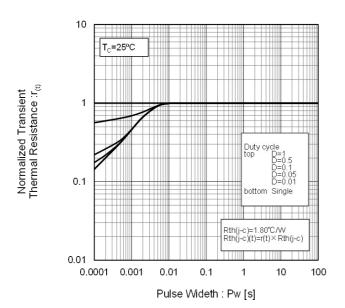
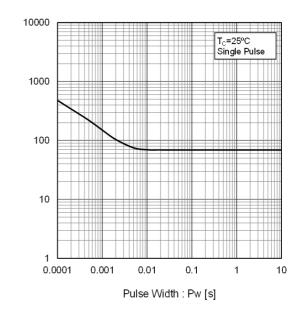


Fig.4 Single Pulse Maximum Power dissipation





Peak Transient Power : P[W]

Drain Current : -I_D [A]

200

27

24

21

18

15

12

9

6

3

0

0 0.1

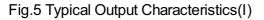
• Electrical characteristic curves

V_{GS} = -10V

V_{GS}= -4.5V

V_{GS}= -4.0V





T_a=25°C Pulsed

V_{GS}= -3.5V

V_{GS}= -3.0V

V_{GS}= -2.5V

1

0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : -V_{DS} [V]

Drain Current : -I_D [A]

 $\begin{array}{c} 27 \\ 24 \end{array}$

Fig.6 Typical Output Characteristics(II)

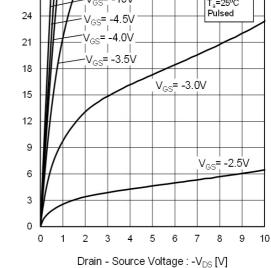
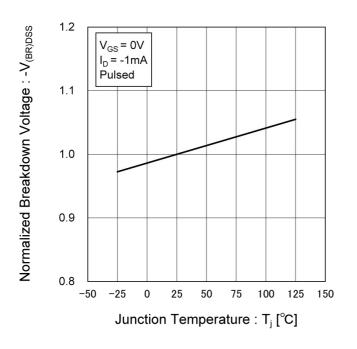


Fig.7 Breakdown Voltage vs. Junction Temperature







Drain Current : -I_D [A]

Datasheet

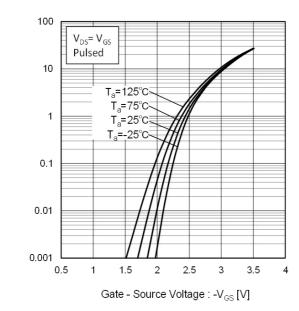
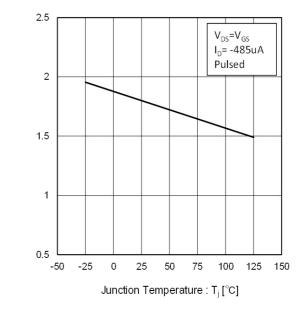


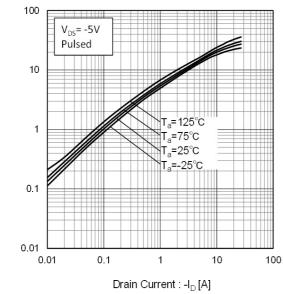
Fig.8 Typical Transfer Characteristics

Fig.9 Gate Threshold Voltage vs. Junction Temperature



Gate Threshold Voltage : -V_{GS(th)} [V]

Fig.10 Forward Transfer Admittance vs. Drain Current



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Forward Transfer Admittance : Y_{f_8} [S]



120

100

80

60

40

20

0 L 0

25

50

• Electrical characteristic curves



Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

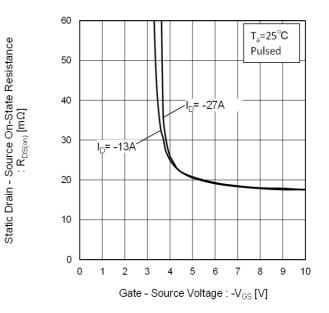


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

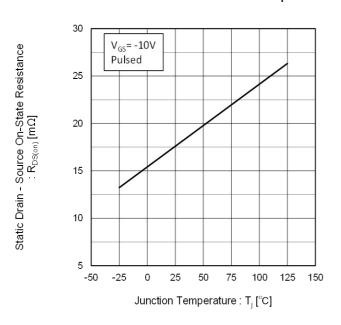
75

Junction Temperature : T_i [°C]

125

150

100





• Electrical characteristic curves

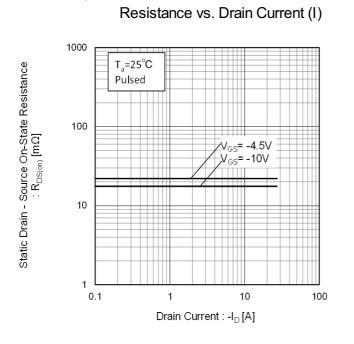
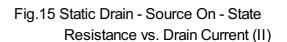


Fig.14 Static Drain - Source On - State



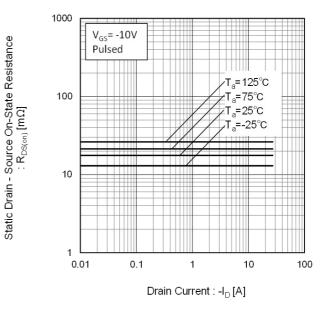
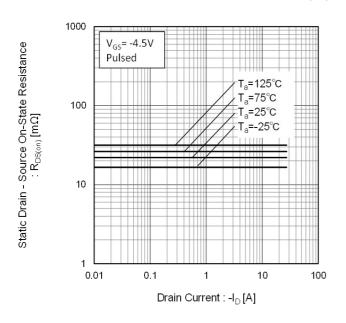


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)





• Electrical characteristic curves

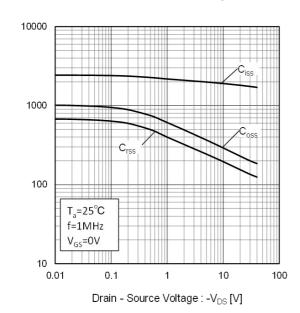


Fig.17 Typical Capacitance vs. Drain - Source Voltage

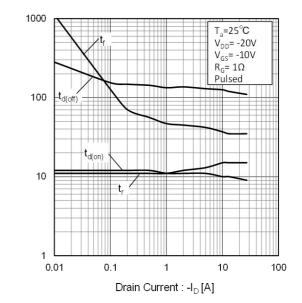


Fig.18 Switching Characteristics

Fig.19 Dynamic Input Characteristics

Gate - Source Voltage : -V_{GS} [V]

Capacitance : C [pF]

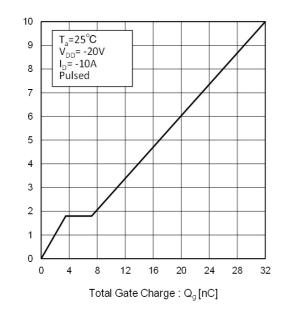
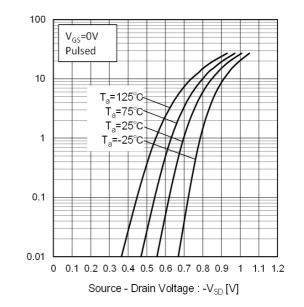


Fig.20 Source Current vs. Source Drain Voltage





Source Current : -I_S [A]

Switching Time : t [ns]

Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

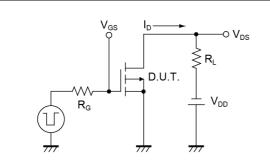


Fig.2-1 Gate Charge Measurement Circuit

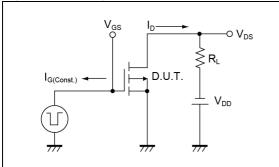


Fig.3-1 Avalanche Measurement Circuit

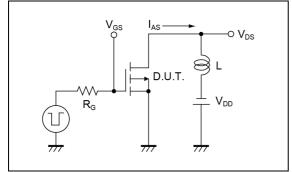


Fig.1-2 Switching Waveforms

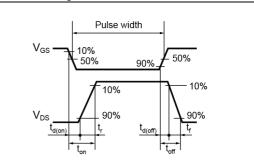


Fig.2-2 Gate Charge Waveform

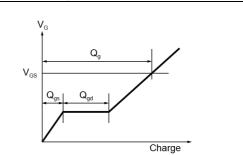
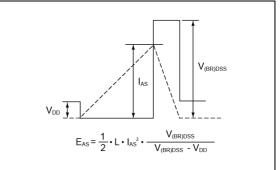


Fig.3-2 Avalanche Waveform

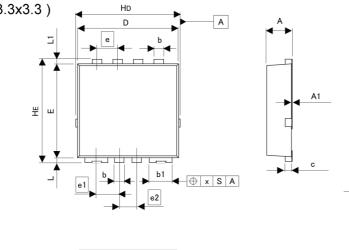


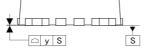


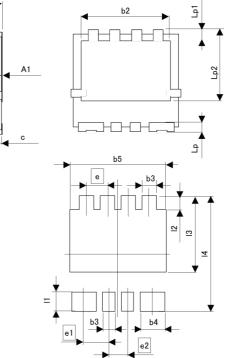
Dimensions



(3.3x3.3)







Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIME	ETERS	INCI	HES
Divi	MIN	MAX	MIN	MAX
A	0.70	0.90	0.028	0.035
A1	0.00	0.05	0.000	0.002
b	0.27	0.37	0.011	0.015
b1	0.69	0.79	0.027	0.031
b2	2.50	2.70	0.098	0.106
с	0.10	0.30	0.004	0.012
D	3.10	3.30	0.122	0.130
E	2.90	3.10	0.114	0.122
e	0.	65	0.0)26
e1	0.	78	0.0)31
e2	0.	57	0.0)22
HD	3.20	3.40	0.126	0.134
HE	3.20	3.40	0.126	0.134
L	0.07	0.25	0.003	0.010
L1	0.07	0.25	0.003	0.010
Lp	0.20	0.40	0.008	0.016
Lp1	0.25	0.45	0.010	0.018
Lp2	2.10	2.50	0.083	0.098
x	-	0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIME	ETERS	INC	HES
Divi	MIN	MAX	MIN	MAX
b3	-	0.47	-	0.019
b4	-	0.89	-	0.035
b5	-	2.70	-	0.106
1	-	0.50	-	0.020
12	-	0.55	-	0.022
13	-	2.40	-	0.094
4	-	3.40	-	0.134

Dimension in mm/inches



Notice

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 If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA
CLASSII	CLASSⅢ	CLASS II b	
CLASSⅣ	CLASSI	CLASSII	CLASSⅢ

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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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